mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

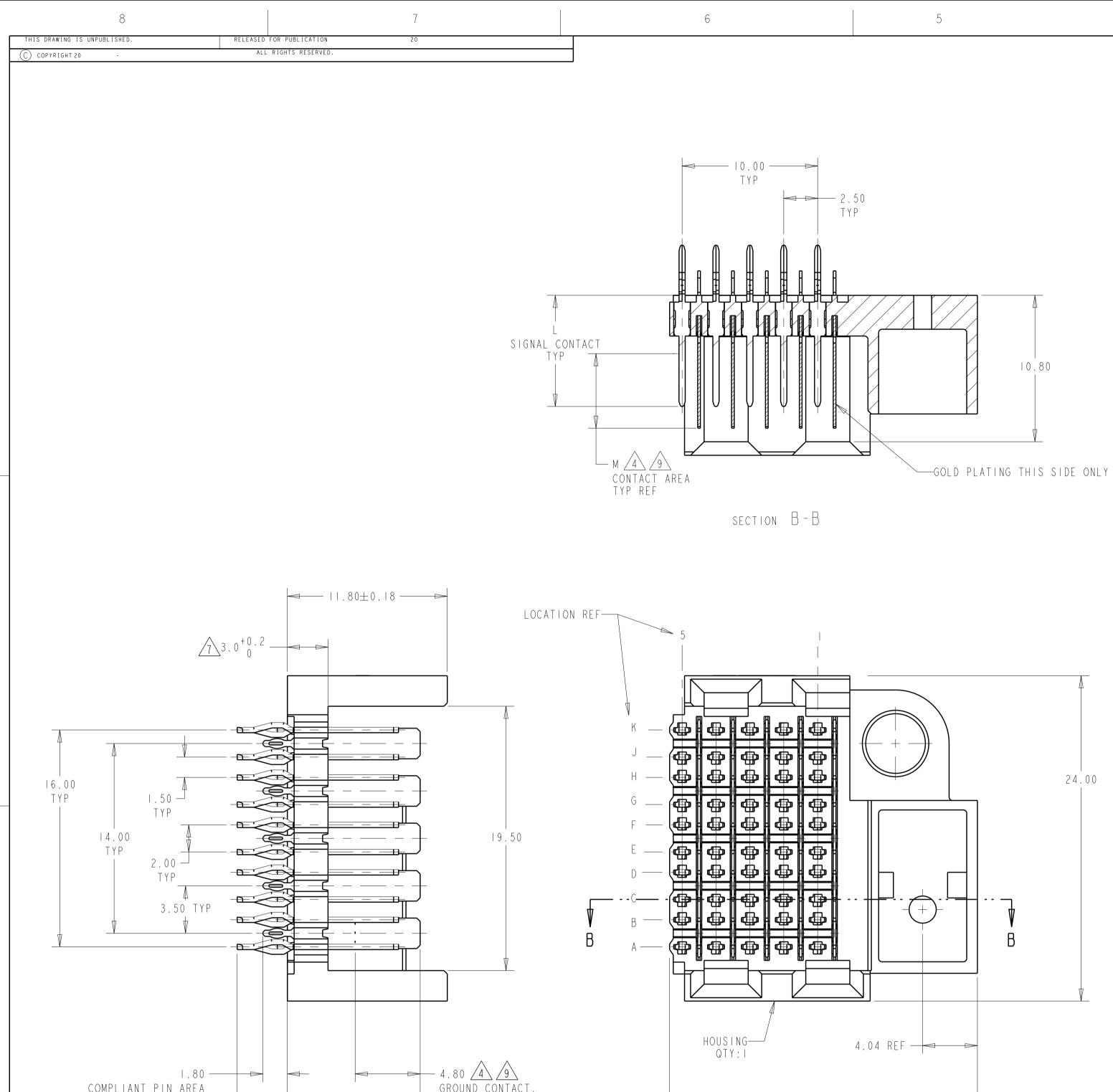
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





— 22.7I±0.I8 —

I II

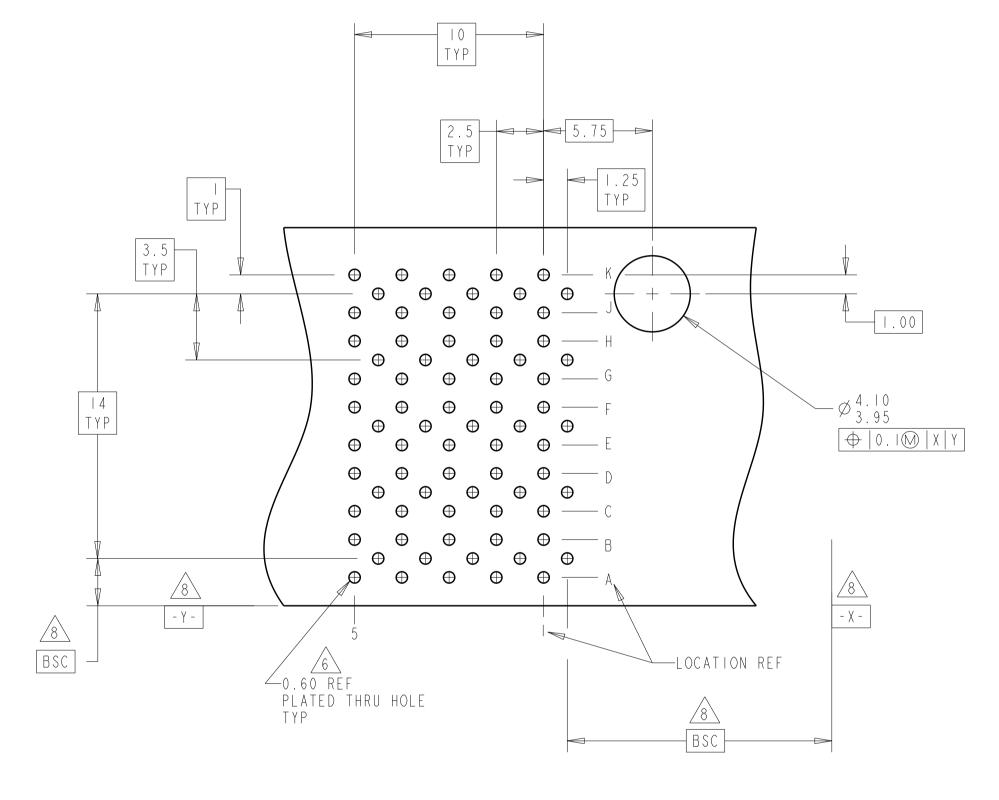
- 4.80 4 9 GROUND CONTACT, CONTACT AREA TYP - 9.8±0.2 GROUND CONTACT TYP

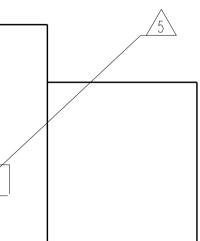
4805 (3/11)

2	PHOSPHOR BRONZE
$\sqrt{3}$. LCP, UL94V-0
4	FINISH: CONTACT MATING AREA MEETS THE PERFORMANCE REQUIREMENTS OF TE CONNECTIVITY PRODUCT SPECIFICATION 108-1957; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS. COMPLIANT PIN AREA: 0.5μm MIN MATTE TIN OVER BASE PLATING.
5	. CONNECTOR MARKED WITH PART NUMBER AND DATE CODE
6	. REFERENCE APPLICATION SPEC 114-13020 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESS.
7	APPLICATION SEATING HEIGHT TO PRINTED CIRCUIT BOARD
8	. DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER
<u>_9</u>	CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT TECHNICAL REFERENCE: GR-I2I7-CORE, ISSUEI, NOVEMBER 1995

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			OBSOLETE	5.30	9.7	75120672-2	
				5.50	8.2	512067	72-1
				M		PART NI	JMB E R
THIS DRAWING IS A	CONTROLLED DOCUMENT.	06DEC04 06DEC04 06DEC04 		-27	E	TE Connectivi	† y
DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±- 1 PLC ±- 2 PLC ±0.13 3 PLC ±0.05	APVD 06DEC04 <u>R.PATTERSON</u> PRODUCT SPEC - APPLICATION SPEC	HEADER ASSEMBLY, 50 POSITION, LEFT HAND, IO ROW, Z-PACK HS3				Ν,
MATERIAL HOUSING: 3	4 PLC ±- ANGLES ±- FINISH	WEIGHT _	A 1 007		no 20672		RESTRICTED TO
CONTACTS: 2	SIGNAL CONTACT: 4	CUSTOMER DRAWING	, , ,		scale 5:	SHEET OF	REV C

		2			1			
LO	2	DIST			REVISIONS			
A	D	00	Р	LTR	DESCRIPTION	DATE	DWN	APVD
				CI	REVISED PER ECO-12-006972	29AUG2012	КН	JE
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RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT component side of printed circuit board